3000 W Low Capacitance Surface Mount in DO-214AB





Agency Approvals

Agency	Agency File Number
A 1	E230531

Maximum Ratings & Thermal Characteristics $(T_{\Delta} = 25 \, ^{\circ}\text{C} \text{ unless otherwise noted})$

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10/1000 µs Waveform (Fig.1)(Note 1)	P _{PPM}	3000	W
Power Dissipation on Infinite Heat Sink at T ₁ = 50 °C	P _D	6.5	W
Operating Temperature Range	T_{J}	-65 to 150	°C
Storage Temperature Range	T _{STG}	-65 to 175	°C

Notes:

1. Non-repetitive current pulse , per Fig. 3 and derated above T, (initial) = 25 °C per Fig. 2.

Description

SMDLCE-HR high reliability series is designed specifically to protect sensitive date line electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

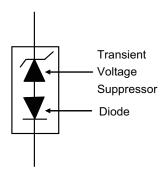
- Low capacitance ≤ 50 pF, 3000 W peak pulse power capability at 10/1000 µs waveform, repetition rate (duty cycles):0.01 %
- For surface mounted applications in order to optimize board space
- Low profile package
- Built-in strain relief
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2 ESD 30 kV (Air), 30 kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4

- Glass passivated chip junction
- Low incremental surge resistance
- Fast response and excellent clamping capability
- UL recognized compound meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, high temperature soldering guaranteed:260 °C/10 seconds at terminals
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applications

- I/O Interfaces for avionics applications, such as flight control, FADEC, radar, and etc.
- Protection for aircraft fast data line

Schematic





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Electrical Characteristics

Part Number	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		Maximum Clamping Voltage @ I _{pp} V _c (V)	Maximum Peak Pulse Current per (Fig.3) I PP (A)	Maximum Junction Capacitance at 0 Volts f = 1 MHZ (pF)	Working Inverse Blocking Voltage V _{WIB} (V)	Inverse Blocking Leakage Current at I _{IB} @ V _{WIB}	Peak Inverse Blocking Voltage V _{PIB} (V)	Agency Approval				
			Min	Max				(A)		(V)	(mA)	(V)	
SMDLCE12-HR	SPEE	12.0	13.30	14.70	1	5	20.9	75.4	50	75	1.0	100	X
SMDLCE13-HR	SPEG	13.0	14.40	15.90	1	3	22.5	139.5	50	75	1.0	100	X
SMDLCE14-HR	SPEK	14.0	15.60	17.20	1	3	24.2	129.3	50	75	1.0	100	X
SMDLCE15-HR	SPEM	15.0	16.70	18.50	1	1	25.4	123.0	50	75	1.0	100	X
SMDLCE16-HR	SPEP	16.0	17.80	19.70	1	1	27.0	115.4	50	75	1.0	100	X
SMDLCE17-HR	SPER	17.0	18.90	20.90	1	1	28.6	108.7	50	75	1.0	100	X
SMDLCE18-HR	SPET	18.0	20.00	22.10	1	1	30.2	102.7	50	75	1.0	100	X
SMDLCE20-HR	SPEV	20.0	22.20	24.50	1	1	33.4	92.6	50	75	1.0	100	Χ
SMDLCE22-HR	SPEX	22.0	24.40	26.90	1	1	36.5	84.5	50	75	1.0	100	Χ
SMDLCE24-HR	SPEZ	24.0	26.70	29.50	1	1	39.9	77.1	50	75	1.0	100	X
SMDLCE26-HR	SPFE	26.0	28.90	31.90	1	1	43.1	71.3	50	75	1.0	100	X
SMDLCE28-HR	SPFG	28.0	31.10	34.40	1	1	46.5	66.1	50	75	1.0	100	X
SMDLCE30-HR	SPFK	30.0	33.30	36.80	1	1	49.4	62.0	50	75	1.0	100	X
SMDLCE33-HR	SPFM	33.0	36.70	40.60	1	1	53.3	56.3	50	75	1.0	100	X
SMDLCE36-HR	SPFP	36.0	40.00	44.20	1	1	58.1	51.6	50	75	1.0	100	X
SMDLCE40-HR	SPFR	40.0	44.40	49.10	1	1	64.5	46.5	50	75	1.0	100	X
SMDLCE43-HR	SPFT	43.0	47.80	52.80	1	1	69.4	43.2	50	75	1.0	100	X
SMDLCE45-HR	SPFV	45.0	50.00	55.30	1	1	72.7	41.3	50	75	1.0	100	X
SMDLCE48-HR	SPFX	48.0	53.30	58.90	1	1	77.4	38.8	50	75	1.0	100	X
SMDLCE51-HR	SPFZ	51.0	56.70	62.70	1	1	82.4	36.4	50	75	1.0	100	X
SMDLCE54-HR	SRGE	54.0	60.00	66.30	1	1	87.1	34.4	50	100	1.0	125	X
SMDLCE58-HR	SPGG	58.0	64.40	71.20	1	1	93.6	32.1	50	100	1.0	125	X
SMDLCE60-HR	SPGK	60.0	66.70	73.70	1	1	96.8	31.0	50	100	1.0	125	X
SMDLCE64-HR	SPGM	64.0	71.10	78.60	1	1	103.0	29.1	50	100	1.0	125	X
SMDLCE70-HR	SPGP	70.0	77.80	86.00	1	1	113.0	26.5	50	125	1.0	150	Χ

Note: Each lot of parts will pass group B test requirement.

Screen Process

100 % vision inspection	MIL-STD-750 method 2074
100 % X-RAY inspection	MIL-STD-750 method 2076
100 % temperature cycle test (-55 °C to150 °C, 20 cycles, dwell time 15 min)	MIL-STD-750 method 1051
100 % reflow (2x)	JEDEC J-STD-020
100 % surge test (2x)	MIL-STD-750 method 4066
100 % HTRB 150 °C bias = V _R (80 % breakdown voltage, 96 hrs)	MIL-STD-750 method 1038
Final electrical test (100 % 3 sigma limit, 100 % dynamic test and PAT limit)	MIL-STD-750 method 4016.4021.4011

 ${\tt Note: Up-screen\ program\ can\ be\ specified\ by\ customer's\ request\ by\ contacting\ Littelfuse\ customer\ service}$



Group B Test Requirement

Screen	Method	Condition	Requirement
Surge test	10/1000 µs peak pulse waveform	Maximum clamping voltage (V _c) @ peak pulse current (I _{PP})	Sample size 45 perform 10x Accept 0 failures
Burn-in (HTRB)	MIL -STD-750, method 1038.5	Applied voltage 100 % V _R @150 °C	Sample size 45 340 hours Accept 0 failures
Electrical test	-	I _R @V _R , V(_{BR})@I _T	Sample size 45 Accept 0 failures

Ratings and Characteristic Curves (T_A = 25 °C unless otherwise noted)

Figure 1 - Peak Pulse Power Rating Curve

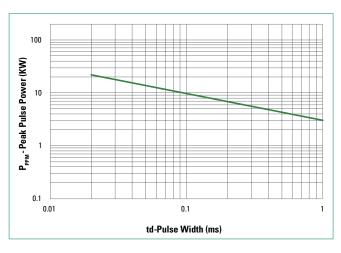


Figure 2 - Peak Pulse Power Derating Curve

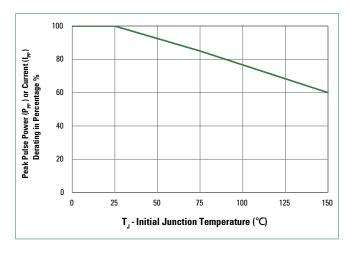


Figure 3 - Pulse Waveform

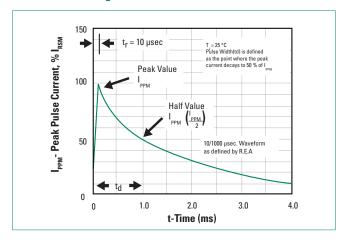
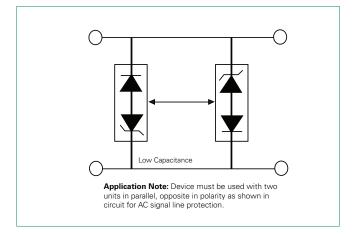


Figure 4 - AC Line Protection Application

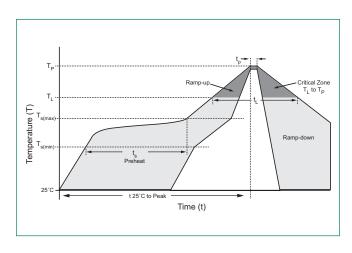




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Soldering Parameters

Reflow Cond	lition	Lead-free assembly			
	-Temperature Min (T _{s(min)})	150 °C			
Pre Heat	-Temperature Max (T _{s(max)})	200 °C			
	-Time (min to max) (t _s)	60 – 180 seconds			
Average Ran Peak	np Up Rate (Liquidus Temp (T _L) to	3 °C/second max			
$T_{\text{S(max)}}$ to T_{L} -	Ramp-up Rate	3 °C/second max			
Reflow	-Temperature (T _L) (Liquidus)	217 °C			
Retiow	-Time (min to max) (t _s)	60 - 150 seconds			
Peak Temper	rature (T _P)	260+0/-5 °C			
Time Within	5 °C of Actual Peak Temperature (t_p)	20 - 40 seconds			
Ramp-down	Rate	6 °C/second max			
Time 25 °C t	o Peak Temperature (T _P)	8 minutes max			
Do Not Exce	ed	260 °C			



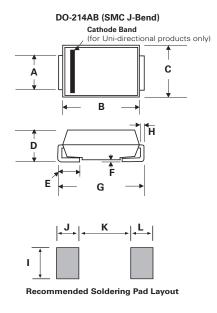
Physical Specifications

Weight	0.003oz., 0.093g
Case	JEDEC DO-214AB molded plastic body over glass passivated junction.
Polarity	Color band denotes cathode except bidirectional
Terminal	Matte Tin-plated leads. Solderable per JESD22-B102

Environmental Specifications

High Temperature Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22A111

Dimensions



Dimensions	Incl	hes	Millimeters					
Dimensions	Min	Max	Min	Max				
Α	0.114	0.126	2.900	3.200				
В	0.260	0.280	6.600	7.110				
С	0.220	0.245	5.590	6.220				
D	0.079	0.103	2.060	2.620				
E	E 0.030		0.760	1.520				
F	-	0.008	-	0.203				
G	0.305	0.320	7.750	8.130				
Н	0.006	0.012	0.152	0.305				
1	0.129	-	3.300	-				
J	0.094	-	2.400	-				
K	-	0.165	-	4.200				
L	0.094	-	2.400	-				

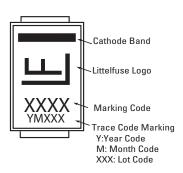


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Part Numbering System



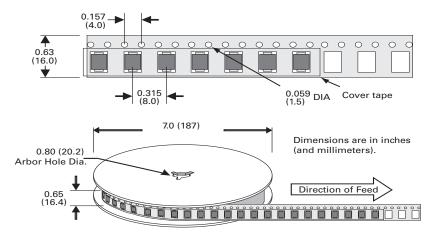
Part Marking System

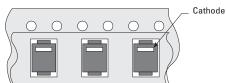


Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMDLCE-HR	DO-214AB	500	Tape & Reel - 16 mm tape/7" reel	EIA STD RS-481

Tape and Reel Specification

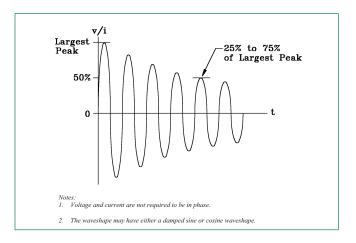




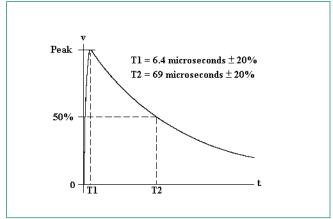


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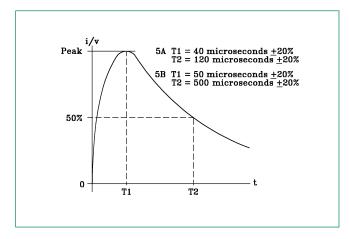
RTCA/DO-160G Wave 3



RTCA/DO-160G Wave 4



RTCA/DO-160G Wave 5





3000 W Low Capacitance Surface Mount in DO-214AB

Pin Injection Protection Per RTCA/DO-160G

	25 °C							70 °C						120 °C				
Part Number	Wave 3			Wave 5a (40/120 μs)		Wave 3			Wave 5a (40/120 μs)		Wave 4 3 (6.4/69 µs)			Wave 5a (40/120 μs)				
Nullibei	L5	L3	L4	L5	L3	L4	L5	L3	L4	L5	L3	L4	L5	L3	L4	L5	L3	L4
	128A	60A	150A	320A	300A	750A	128A	60A	150A	320A	300A	750A	128A	60A	150A	320A	300A	750A
SMDLCE12-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-
SMDLCE13-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-
SMDLCE14-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-
SMDLCE15-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-
SMDLCE16-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-	pass	pass	pass	-	-	-
SMDLCE17-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-	pass	pass	pass	-	-	-
SMDLCE18-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-	pass	pass	pass	-	-	-
SMDLCE20-HR	pass	pass	pass	pass	pass	-	pass	pass	pass	pass	-	-	pass	pass	pass	-	-	-
SMDLCE22-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE24-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE26-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE28-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE30-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE33-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE36-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE40-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-
SMDLCE43-HR	pass	pass	pass	-	-	-	pass	pass	pass	-	-	-	pass	pass	-	-	-	-
SMDLCE45-HR	pass	pass	pass	-	-	-	pass	pass	-	-	-	-	pass	pass	-	-	-	-
SMDLCE48-HR	pass	pass	pass	-	-	-	pass	pass	-	-	-	-	pass	pass	-	-	-	-
SMDLCE51-HR	pass	pass	pass	-	-	-	pass	pass	-	-	-	-	pass	pass	-	-	-	-
SMDLCE54-HR	pass	pass	pass	-	-	-	pass	pass	-	-	-	-	pass	pass	-	-	-	-
SMDLCE58-HR	pass	pass	-	-	-	-	pass	pass	-	-	-	-	pass	pass	-	-	-	-
SMDLCE60-HR	pass	pass	-	-	-	-	pass	pass	-	-	-	-	pass	pass	-	-	-	-
SMDLCE64-HR	pass	pass	-	-	-	-	pass	pass	-	-	-	-	pass	-	-	-	-	-
SMDLCE70-HR	pass	pass	-	-	-	-	pass	pass	-	-	-	-	pass	-	-	-	-	-

Note:

1. L1 = Level 1, L2 = Level 2, L3 = Level 3, L4 = Level 4, L5 = Level 5

